FORM PTO-1595 (Rev. 6-93)

09-22-2008

DEPARTMENT OF COMMERCE Patent and Trademark Office **EET**

To the Commissioner for Potents 103525	Attorney Docket No.: 065542-5042		
To the Commissioner for Faterits			
Please record the attached original documents or copy thereof.			
1. Name of conveying party(ies):	Name and address of receiving party(ies):		
	Name: MagnaChip Semiconductor, Ltd.		
Sawada KAZUYOSHI			
Additional names of conveying party(ies) attached? ☐ Yes ⊠ No	Internal Address:		
	Street Address: 1 Hyangjeong-dong, Heungduk-gu Cheongju-si, Chungcheongbuk-do 361-725, Republic of Korea		
3. Nature of conveyance:	City:		
•	State: Zip:		
Assignment	Additional name(s) & address(es) attached?		
	☐ Yes ⊠ No		
4. New Application number(s) or patent number(s): 11/	723,864		
If this document is being filed together with a new application the execution date of the application is: A. Patent Application No.(s) 11/723,864 B. Patent No.(s)			
Additional numbers attached: ☐Yes ☒No			
5. Name and address of party to whom correspondence concerning document should be mailed:	 6. Total number of applications and patents involved: 1 7. Total fee (37 C.F.R. §3.41): \$40.00 		
Name: Collin W. Park	☐ Enclosed ☐ Authorized to be charged to Deposit Account 50-0310		
Internal Address: Morgan, Lewis & Bockius LLP Customer No. 09629	8. Deposit Account No. 50-0310 (Attach duplicate page if paying by deposit account)		
Street Address: 1111 Pennsylvania Ave., N.W.			
City: Washington State: D.C. Zip: 20004			
Old American discontinuo			
9. Statement and Signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true			
To the best of my knowledge and benef, the foregoing information is the and to the same and to the same and t			
copy of the original document.			
Collin W. Park, Reg. No. 43,378 Signature Signature September 17, 2008 Date			
Name of Person Signing Signature Total number of pages including cover sheet, attachments and documents: 2			

09/19/2008 DBYRNE 00000022 500310 11/23864 01 FC:8021 48.88 DA

PATENT REEL: 021575 FRAME: 0501

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled: OPERATIONAL AMPLIFIER

	ted States Letters Patent concurrently herewith; o	r filed an application for United
States Letters Patent on, (Serial	; and	
1 Hyangjeong-dong, Heungduk-gu, Cheongju-s	or Ltd., a corporation of Republic of Korea, who is, Chungcheongbuk-do, 361-725, Republic of Korea, title, and interest in and to this invention, the apo be issue upon this application;	rea, (hereinafter referred to as
acknowledged, I/WE, as assignor(s), have sold, unto the assignee, its lawful successors and assi application, and all divisions, and continuations all reissues thereof; and I/WE hereby authorize	, for good and valuable consideration the receipt of assigned, transferred, and set over, and do hereby gns, MY/OUR entire right, title, and interest in an thereof, and all Letters Patent of the United State and request the Commissioner of Patents and Tracits successors and assigns, in accordance with the	sell, assign, transfer, and set over and to this invention and this s which may be granted thereon, and demarks of the United States to issue
its successors and assigns, any facts known to M papers when called upon to do so, execute and d in said assignee, its successors and assigns, exec generally do everything possible to aid assignee invention in the United States, it being understo assignee, its successors and assigns. AND, I/WE HEREBY authorize and re-	at and agree that I/WE will, without further consider I/WS respecting this invention and testify in any deliver all papers that may be necessary or desirable cute all divisional, continuation, and reissue application, its successors and assigns, to obtain and enforce and that any expense incident to the execution of sequest the attorneys I/WE have empowered in the (Application No, filed 22Mar.	legal proceeding, sign all lawful le to perfect the title to this inventior cations, make all rightful oaths and proper patent protection for this uch papers shall be borne by the Declaration and Power of Attorney
IN TESTIMONY WHEREOF, I/WE h	ave bereinto set our hand(s).	
Full Name of Sole or First Assignor Sawada Kazuyoshi	Assignor's Signature Assignor's Annada Kaguyoshi.	Date 28/02/2007
Address:	V V	Citizenship /
Shin-Osaka 2nd. MT bldg., 3-5-36, Miyahara, Yodogawa-ku, Osaka-si, Osaka 532-0003, Japan		Japan
Full Name of Second Assignor	Assignor's Signature	Date
Address:		Citizenship
Full Name of Third Assignor	Assignor's Signature	Date
Address:		Citizenship
		Date
Full Name of Fourth Assignor	Assignor's Signature	
		Citizenship
Address		

Morgan, Lewis & Bockius LLP

⊠No

Yes

1-WA/2399560.1

Names of additional inventors attached

RECORDED: 09/17/2008

PATENT REEL: 021575 FRAME: 0502